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Attorney's Docket No. 042390.P5778D
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Krishna Seshan; M. Lawrence A. Dass; and Geoffrey L. Bakker

Serial No.

Filed: **November 6, 2001**

For: **Semiconductor Passivation Deposition Process for Interfacial Adhesion (Amended)**

Divisional Application of:

Serial No. 09/105,590

Filed: June 26, 1998

Examiner: Brophy, J.

Art Unit 2822

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10/013103
11/06/01

INFORMATION DISCLOSURE STATEMENT

In accordance with 37 C.F.R. § 1.56, Applicants hereby disclose the prior art references that have been submitted and/or cited in related application, as follows:

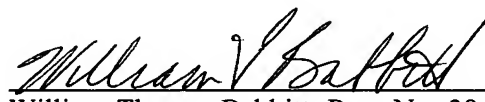
U.S. Serial No. 09/105,590, filed June 26, 1998.

A copy of form PTO-892 filed in the related application is enclosed. Copies of the references are not provided as permitted by 37 C.F.R. § 1.98(d).

Respectfully submitted,

BLAKELY, SOKOLOFF, TAYLOR & ZAFMAN, LLP

Date: 11/6/01



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